



PS9151

Data Sheet

R08DS0108EJ0300 Rev.3.00 Apr 09, 2013

HIGH NOISE REDUCTION, 15 Mbps CMOS OUTPUT TYPE, 5-PIN SOP (SO-5) PHOTOCOUPLER

DESCRIPTION

The PS9151 is an optically coupled isolator containing a GaAlAs LED on the input side and a CMOS output IC on the output side.

This photocoupler is high common mode transient immunity (CMR), a high-speed CMOS output type device designed for high-speed logic interface circuits.

FEATURES

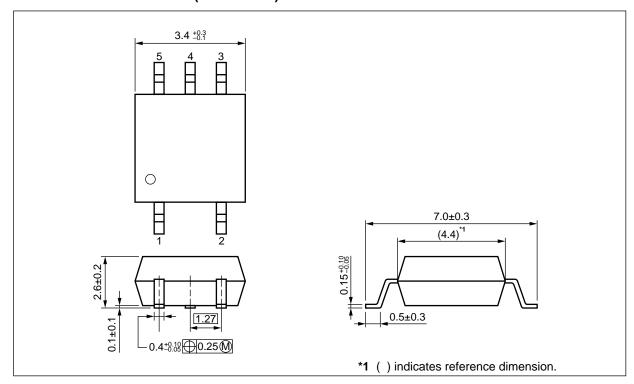
- High-speed response (15 Mbps)
- Operable at high temperature ($-40 \text{ to } +100^{\circ}\text{C}$)
- High common mode transient immunity (CM_H, CM_L = $\pm 20 \text{ kV}/\mu \text{s}$ TYP.)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Pulse width distortion ($|t_{PHL} t_{PLH}| = 3 \text{ ns TYP.}$)
- Ordering number of tape product : PS9151-F3: 2 500 pcs/reel
- Pb-Free product
- <R> Safety standards
 - UL approved: No. E72422
 - DIN EN 60747-5-5 (VDE 0884-5) approved (Option)

PIN CONNECTION (Top View) 5 4 3 1. Anode 2. Cathode 3. GND 4. Vo 5. VDD

APPLICATIONS

- FA Network
- Measurement equipment
- PDP

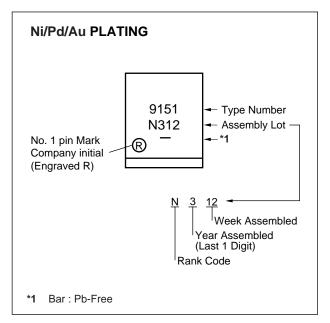
<R> PACKAGE DIMENSIONS (UNIT: mm)



<R> PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	4.2 mm
Outer Creepage Distance	4.2 mm
Isolation Distance	0.2 mm

<R> MARKING EXAMPLE





$^{ extsf{<}R>}$ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS9151	PS9151-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9151
PS9151-F3	PS9151-F3-AX	(Ni/Pd/Au)	Embossed Tape 2 500 pcs/reel	(UL, CSA approved)	
PS9151-V	PS9151-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN 60747-5-5	
PS9151-V-F3	PS9151-V-F3-AX		Embossed Tape 2 500 pcs/reel	(VDE 0884-5) approved (Option)	

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current *1	l _F	20	mA
	Reverse Voltage	V_R	5	V
Detector	Supply Voltage	V_{DD}	0 to 5.5	V
	Output Voltage	Vo	-0.5 to V _{DD} +0.5	V
	Output Current	Io	2	mA
Isolation \	Isolation Voltage *2		3 750	Vr.m.s.
Operating Ambient Temperature		T _A	-40 to +100	°C
Storage Temperature		T _{stg}	-55 to +125	°C

Notes: *1. Reduced to 0.8 mA/°C at $T_A = 95$ °C or more.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Forward Current	I _F	10		16	mA
Supply Voltage	V_{DD}	4.5	5.0	5.5	V

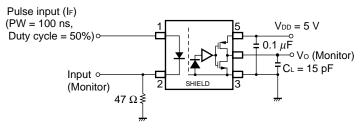
^{*2}. AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.

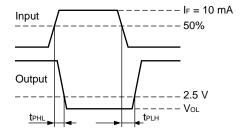


<R> ELECTRICAL CHARACTERISTICS (T_A = -40 to +100°C, V_{DD} = 4.5 to 5.5 V, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 10 mA, T _A = 25°C	1.4	1.65	1.8	V
	Reverse Current	I _R	V _R = 3 V, T _A = 25°C			10	μΑ
	Terminal Capacitance	Ct	$V = 0 V, f = 1 MHz, T_A = 25^{\circ}C$		30		pF
Detector	High Level Supply Current	I _{DDH}	I _F = 0 mA		2.5	5	mA
	Low Level Supply Current	I _{DDL}	I _F = 10 mA,		2	5	
	High Level Output Voltage	I _{CCH}	$I_{O} = -20 \ \mu\text{A}, I_{F} = 0 \ \text{mA}$	4	5		V
	Low Level Output Voltage	V _{OL}	$I_O = 20 \ \mu\text{A}, I_F = 10 \text{ mA}$		0	0.1	
Coupled	Threshold Input Voltage	I _{FHL}	V _O < 1 V		2.2	5	mA
	Isolation Resistance	R _{I-O}	$V_{I-O} = 1 \text{ kV}_{DC}$, RH = 40 to 60%, $T_A = 25^{\circ}\text{C}$	10 ¹¹			Ω
	Isolation Capacitance C		V = 0 V, f = 1 MHz, T _A = 25°C		0.6		pF
	Propagation Delay Time $(H \rightarrow L)^{*2}$	t _{PHL}	I_F = 10 mA, V_{DD} = 5 V, C_L = pF, CMOS Levels		35	60	ns
	Propagation Delay Time $(L \rightarrow H)^{*2}$	t _{PLH}			35	60	
	Pulse Width Distortion (PWD)*2	t _{PHL} —t _{PLH}			3	30	
	Propagation Delay Skew	t psk				40	
	Rise Time	t r			4		
	Fall Time	tr			4		
	Common Mode Transient Immunity at High Level Output ^{*3}	CM _H	$V_{DD} = 5 \text{ V}, I_F = 0 \text{ mA},$ $V_{CM} = 1 \text{ kV}, V_O > 4 \text{ V},$ $T_A = 25^{\circ}\text{C}$	15	20		kV/μs
	Common Mode Transient Immunity at Low Level Output*3	CM _L	$V_{DD} = 5 \text{ V}, I_F = 10 \text{ mA},$ $V_{CM} = 1 \text{ kV}, V_O < 1 \text{ V},$ $T_A = 25^{\circ}\text{C}$	15	20		

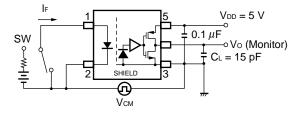
- Notes: *1. Typical values at $T_A = 25^{\circ}C$
 - *2. Test circuit for propagation delay time

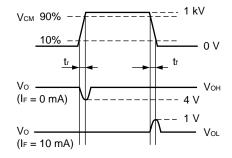




Remark CL includes probe and stray wiring capacitance.

*3. Test circuit for common mode transient immunity





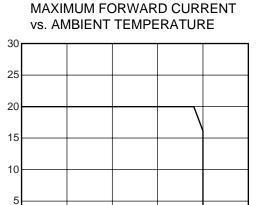
Remark C_L includes probe and stray wiring capacitance.

Maximum Forward Current IF (mA)

0

TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

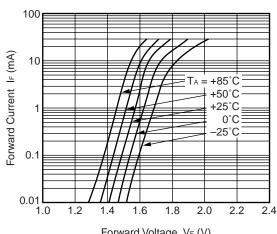
125



Ambient Temperature TA (°C)

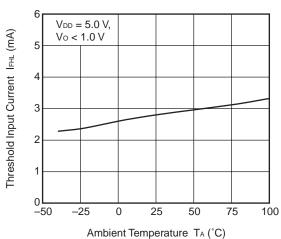
25

FORWARD CURRENT vs. FORWARD VOLTAGE

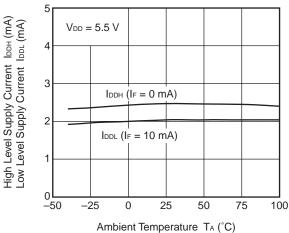


Forward Voltage V_F (V)

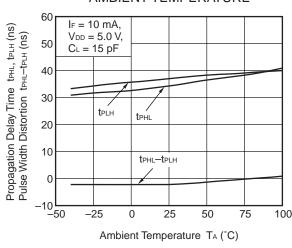
THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



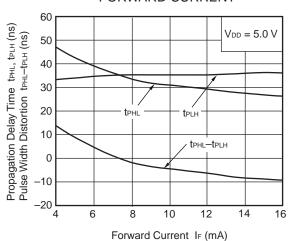
SUPPLY CURRENT vs. AMBIENT TEMPERATURE



tphl, tplh, tphl-tplh vs. AMBIENT TEMPERATURE

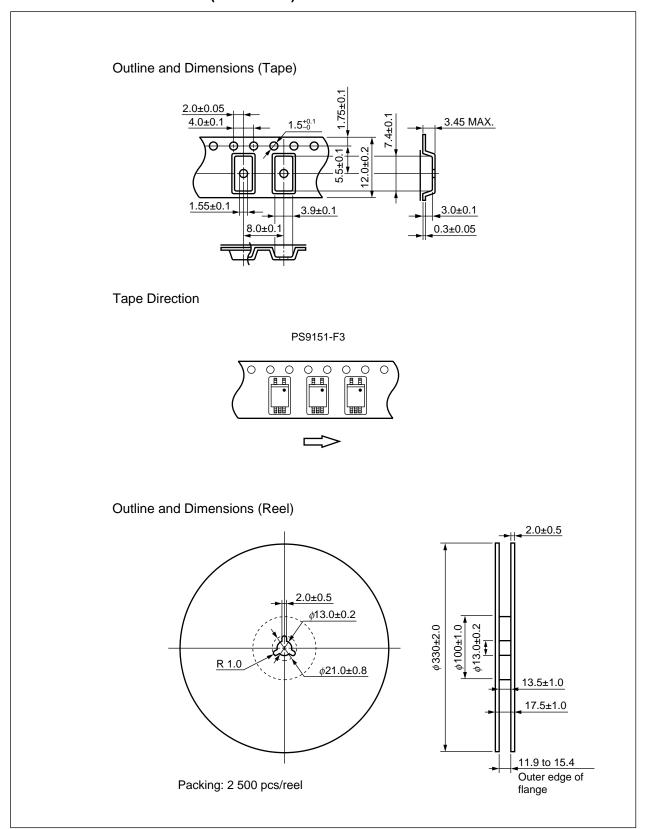


tphl, tplh, tphl-tplh vs. FORWARD CURRENT

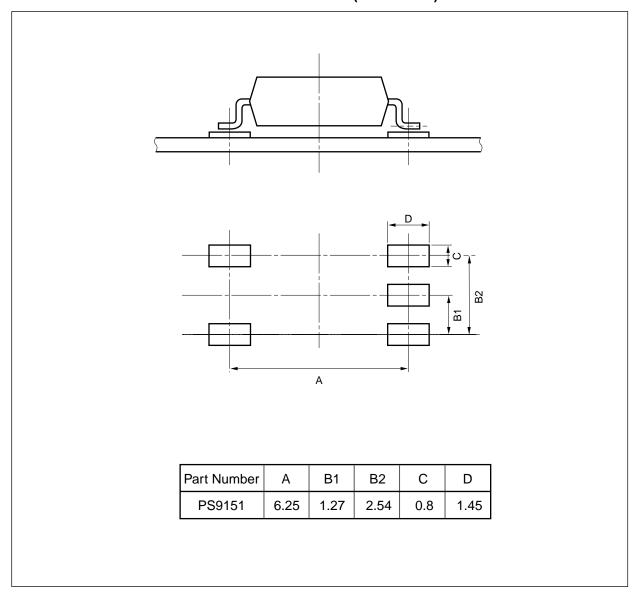


Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)



<R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



<R> NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering

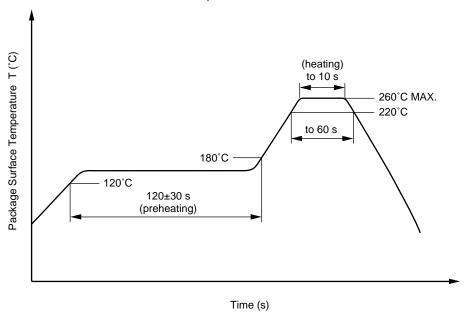
• Peak reflow temperature 260°C or below (package surface temperature)

Time of peak reflow temperature 10 seconds or less
 Time of temperature higher than 220°C 60 seconds or less

Time to preheat temperature from 120 to 180°C
 Number of reflows
 Three or less

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% or less is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% or less is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature) 350°C or below

Time (each pin) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% or less is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions Regarding Noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.



USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F or more is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is 10 mm or less.
- <R> 3. When V_{DD} is lower than around 2 V, the output(V_o) of this product is unstable, and this might produce undesirable operation. Be sure to check the operation of an IC or a discrete component that is connected to this product during Power-up and Power-down process. And we recommend to use a disable function (shutdown function) of the connected IC or a reset IC to avoid this undesirable operation.
 - 4. Avoid storage at a high temperature and high humidity.



<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit	
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/100/21		
Dielectric strength				
maximum operating isolation voltage	U _{IORM}	707	V_{peak}	
Test voltage (partial discharge test, procedure a for type test and	U_pr	1 131	V_{peak}	
random test)				
$U_{pr} = 1.6 \times U_{IORM}, P_d < 5 pC$				
Test voltage (partial discharge test, procedure b for all devices)	U_pr	1 326	V_{peak}	
U_{pr} = 1.875 × U_{IORM} , P_d < 5 pC				
Highest permissible overvoltage	U_{TR}	6 000	V_{peak}	
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2		
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303	CTI	175		
Part 11))				
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a		
Storage temperature range	T _{stg}	-55 to +125	°C	
Operating temperature range	T _A	-40 to +100	°C	
Isolation resistance, minimum value				
$V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$	Ris MIN.	10 ¹²	Ω	
V _{IO} = 500 V dc at T _A MAX. at least 100°C	Ris MIN.	10 ¹¹	Ω	
Safety maximum ratings (maximum permissible in case of fault, see				
thermal derating curve)				
Package temperature	Tsi	150	°C	
Current (input current I _F , P _{si} = 0)	Isi	200	mA	
Power (output or total power dissipation)	Psi	300	mW	
Isolation resistance				
V_{IO} = 500 V dc at T_A = Tsi	Ris MIN.	10 ⁹	Ω	

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

Revision History

PS9151 Data Sheet

		Description		
Rev.	Date	Page Summary		
1.00	Aug 22, 2008	-	First edition issued	
2.00	Aug 27, 2008	_	Second edition issued	
3.00	Apr 09, 2013	Throughout	Renesas format is applied to this data sheet.	
		p.1	Modification of FEATURES	
		p.2	Modification of PACKAGE DIMENSIONS	
			Addition of PHOTOCOUPLER CONSTRUCTION	
			Modification of MARKING EXAMPLE	
		p.3	Modification of ORDERING INFORMATION	
		pp.4, 5	Modification of ELECTRICAL CHARACTERISTICS	
		p.9	Modification of RECOMMENDED MOUNT PAD DIMENSIONS	
		pp.10, 11	Modification of NOTES ON HANDLING	
		p.12	Addition of SPECIFICATION OF VDE MARKS LICENSE DOCUMENT	

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